

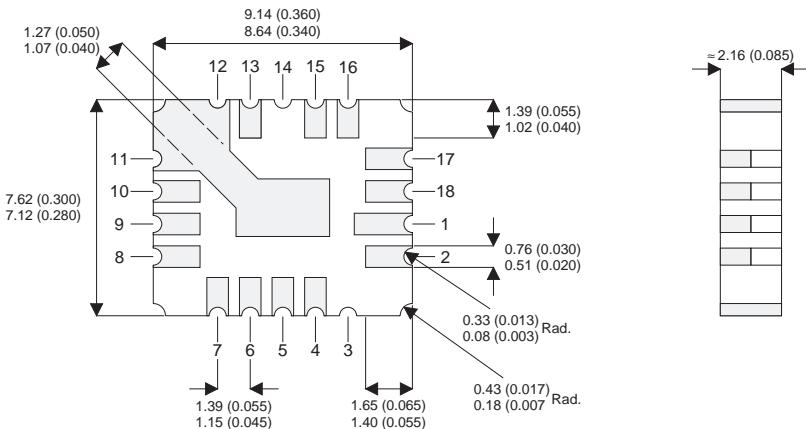


**SEME
LAB**

2N6796LCC4

MECHANICAL DATA

Dimensions in mm (inches)



N-CHANNEL POWER MOSFET

V_{DSS} = 100V

I_D = 7.4A

R_{DS(ON)} = 0.18Ω

FEATURES

- Hermetically sealed ceramic surface mount package
- Small footprint
- Simple drive requirements

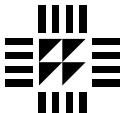
LCC4 CERAMIC SURFACE MOUNT PACKAGE

Underside View

Pads 6, 7, 8, 9, 10, 11, 12, 13.	Source
Pads 4,5	Gate
Pads 1,2,15,16,17,18	Drain
Pads 3,14	Not Connected

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^\circ\text{C}$ unless otherwise stated)

V_{DS}	Drain–Source Voltage	100V
V_{DGR}	Drain–Gate Voltage ($V_{GS} = 1.0\text{m}\Omega$)	100V
V_{GS}	Gate–Source Voltage	$\pm 20\text{V}$
I_D	Drain Current Continuous	7.4A
I_{DM}	Drain Current Pulsed	30A
P_D	Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	22W $0.17^\circ\text{C}/\text{W}$
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150°C
THERMAL CHARACTERISTICS		
$R_{\theta JC}$	Thermal Resistance Junction to Case	5.0°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	175°C/W
T_L	Maximum Lead Temperature 1.5mm from Case for 10 secs.	300°C



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Parameter	Test Conditions		Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
$V_{(BR)DSS}$	Drain–Source Breakdown Voltage	$V_{GS} = 0$	$I_D = 0.25\text{mA}$	100		V
		$V_{DS} = \text{Rated } V_{DS}$	$V_{GS} = 0$		250	
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80\text{V}$	$V_{GS} = 0\text{A}$		1000	μA
			$T_J = 125^\circ\text{C}$			
I_{GSSF}	Gate–Body Leakage, Forward	$V_{DS} = 0$	$V_{GS} = 20\text{V}$		100	nA
I_{GSSR}	Gate–Body Leakage, Reverse	$V_{DS} = 0$	$V_{GS} = -20\text{V}$		-100	
ON CHARACTERISTICS						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$	$I_D = 0.5\text{mA}$	2	4	V
$R_{DS(\text{on})}$	Static Drain–Source On–Resistance	$V_{GS} = 10\text{V}$	$I_D = 4.7\text{A}$		0.18	Ω
			$T_A = 125^\circ\text{C}$		0.35	
$V_{DS(\text{on})}$	Drain–Source On–Voltage	$V_{GS} = 15\text{V}$	$I_D = 7.4\text{A}$		1.56	V
$g_f S$	Forward Transconductance	$V_{GS} = 15\text{V}$	$I_D = 4.7\text{A}$	3	9	mhos
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	$V_{DS} = 25\text{V}$ $V_{GS} = 0$ $f = 1.0\text{MHz}$		350		900
C_{oss}	Output capacitance			150		500
C_{rss}	Reverse Transfer Capacitance			50		150